TECHNICAL DATA SHEET My-T-Bond® 2710 (A&B)

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Product Description

My-T-Bond® 2710 (A&B) is a clear, medium viscosity, room temperature curing 2K-Epoxy system. After curing it cures to a tough polymer and develops good bonding strength with various plastics and metals substrates. It has good petrol and diesel resistance.

Applications:

- Used for industrial assemblies for multipurpose applications.
- Also suitable for bonding, potting and encapsulating electronic components.

Properties

Technology **Epoxy** 2K Components Mix ratio by weight 2:1

Part A: Part B

Appearance (mix) Clear

> Part A Clear Part B Clear

Viscosity Brookfield DV II + Pro, At 25±2 °C,

Spindle no. 6, Speed 20 r.p.m.

Part A : 11000 - 13000 cP : Part B 14000 - 16000 cP

Specific Gravity, At 25±2 °C

Part A : 1.19 Part B: 1.04

-30 °C to 150°C Temperature Range Applications Bonding, potting

and encapsulation.

Cure Properties

Cure Room temperature Pot Life 18 - 20 minutes **Total Cure** 24 Hours

Adhesive Properties of Cured Material

Lap Shear Strength, ASTM D1002; After 24 hrs.

MS - MS: $\geq 6 \text{ N/mm}^2$ Copper to Delrin: $\geq 1.5 \text{ N/mm}^2$ Tensile Strength, ASTM D897; After 24 hrs.

> MS - MS : $> 7 \text{ N/mm}^2$

Hardness. Durometer Shore D, ASTM D2240

80±3

After 24 hrs.

Directions for Use

For best performance, clean substrates to remove dust, grease, oil etc.

For Hand use:

- To use, weighed separately epoxy resin (Part A) & Hardener (Part B) as per the specified quantity in the mixing ratio & mix to uniform consistency & apply.
- Mix small quantity at a time, so that the mixed material is consumed within a work life time.
- Higher temperature and large quantity will shorten work life time.

For use of cartridge with Dispending gun

- Remove cap from tips. Affix static mixer.
- Insert cartridge into applicator gun.
- Pull trigger and epoxy will mix properly as it is dispensed.

Working

- Working time and cure time depends on temperature and mass:
- The higher the temperature, the faster the cure.
- The larger the mass of the material mixed, the faster the cure.
- To speed the cure of epoxies at low temperatures:
 - Store epoxy at room temperature.
 - Pre-heat repair surface until warm to the touch.
- To slow the cure of epoxies at high temperatures:
 - Mix epoxy in small masses to prevent rapid
 - Cool resin/hardener component(s).

Pack Size

My-T-Bond® 2710 (A&B) is available in 50 ml and 400 ml dual cartridge. Also available in 1 kg and 5 kg packing containers.

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Storage and Handling

- ❖ Store product in a cool and dry location in unopened containers preferably at 20°C
- Keep away from moisture, direct sunlight & heat
- My-T-Bond® 2710 (A&B) will exhibit a shelf life of 6 months from the date of manufacture when stored as mentioned above.
- To prevent contamination of unused product, do not return any material to its original container. For further specific information, contact our technical service center.

Note

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